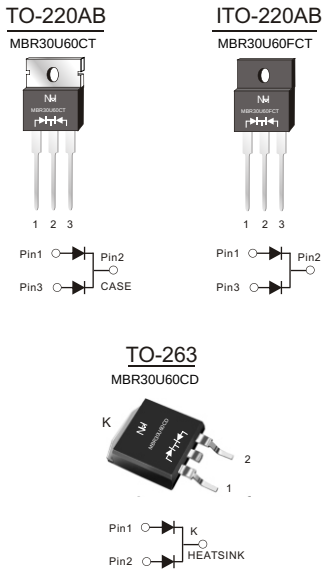
MBR30U60CT,MBR30U60FCT,MBR30U60CD

SUPER LOW VF SCHOTTKY RECTIFIERS

VOLTAGE	60Volts	CURRENT	30 Amperes

TO-220AB/ITO-220AB/TO-263 Unit:(mm)



FEATURES

- Power pack
- Metal silicon junction ,majority carrier conduction
- Guard ring for overvoltage protection
- Low power loss ,high efficiency
- High current capability ,low forward voltage drop
- High forward surge capability
- High frequency operation
- Meets MSL Level 1，per J-STD-020, LF MAX peak of 245℃（for TO-263 package）
- Solder bath temperature 275℃ maximum，10s，per JESD22-B106（for TO-220AB and ITO-220AB package）
- Component in accordance to RoHS 2011/65/EU

MECHANICAL DATA

- Case: JEDEC TO-220AB、ITO-220AB、TO-263
- Molding compound meets UL94V-0 flammability rating
- Terminals: Lead solderable per J-STD-002 and JESD22-B102
- Polarity: As marked
- Mounting Torque: 10 in-lbs maximum

TYPICAL APPLICATIONS

For use in low voltage ,high frequency inverters ,DC/DC converters, free wheeling ,and polarity protection applications

Absolute Maximum Ratings

Parameter		Symbol	MBR30U60CT/MBR30U60FCT/MBR30U60CD	Unit
Maximum repetitive peak reverse voltage		V_{RRM}	60	V
Maximum average forward rectified current (see fig.1)	Per leg	$I_{F(AV)}$	15.0	A
	Total device		30.0	
Peak forward surge current 8.3ms single half sine-wave superimposed on rated load (JEDEC method at rated TL)		I_{FSM}	300	A
Peak repetitive reverse current per diode at tp=2μs 1KHz		I_{RRM}	0.5	A
Operating junction and Storage temperature range		T_J ,T_{stg}	-55 to+150	℃
Isolation voltage (ITO-220AB only) from terminals to heatsink t=1 min		V_{AC}	1500	V

Electricity Character

Parameter	Test Conditions		Symbol	TYP.	MAX.	Unit
Instaneous forward voltage	Per leg IF=15.0A	T_A=25℃	V_F 1)	0. 51	0. 55	V
		T_A=100℃		0. 48	–	
		T_A=125℃		0. 46	–	
	Per leg IF=5.0A	T_A=25℃		0. 38	0. 42	
		T_A=100℃		0. 35	–	
		T_A=125℃		0. 33	–	
Reverse current	VR=60V	T_A=25℃	I_R 2)	60	150	μA
		T_A=100℃		5	10	mA
		T_A=125℃		20	50	
Typical junction capacitance	4V, 1MHz		C_J	570		pF

Notes: 1.Pulse test: 300 μs pulse width,1% duty cycle
2.Pulse test: pulse width≤40ms

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RATINGANDCHARACTERISTICCURVES

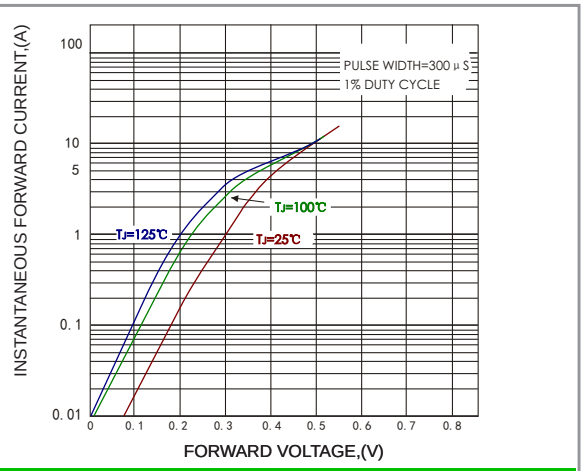

Fig.1-TYPICAL INSTANTANEOUS FORWARD

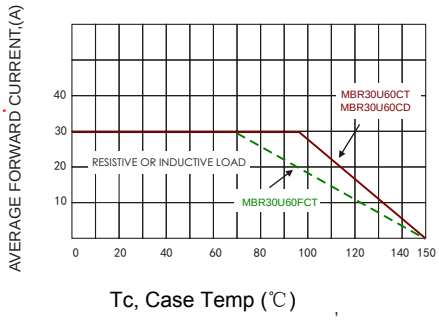

Fig.2- FORWARD CURRENT DERATING CURVE

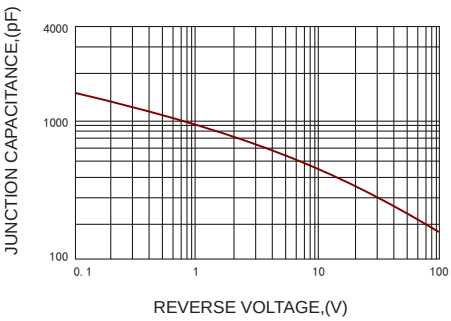

Fig.3- TYPICAL JUNCTION CAPACITANCE

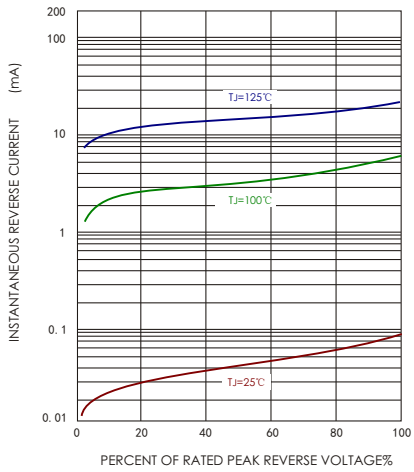

Fig.4- TYPICAL REVERSE CHARACTERISTICS

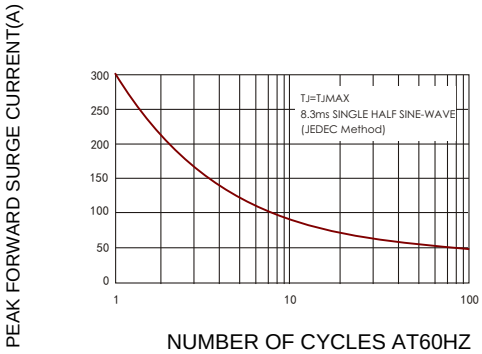

Fig.5-MAX. NON-REPETITIVE SURGE CURRENT

Thermal Characteristcs (Ratings at 25℃ ambient temperature unless otherwise specified)

Parameter	Symbol	MBR30U60CT	MBR30U60FCT	MBR30U60CD	Unit
Typical thermal resistance 3)	RθJC	2.2	4.0	2.2	℃/W

3.Thermal resistance from junction to case

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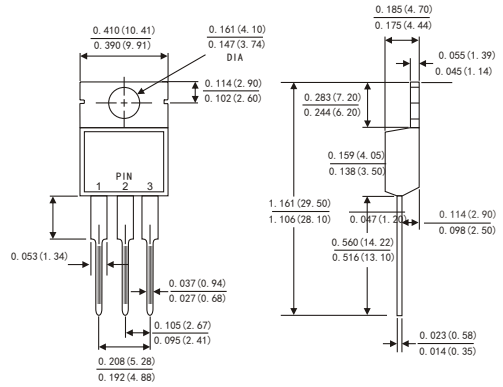
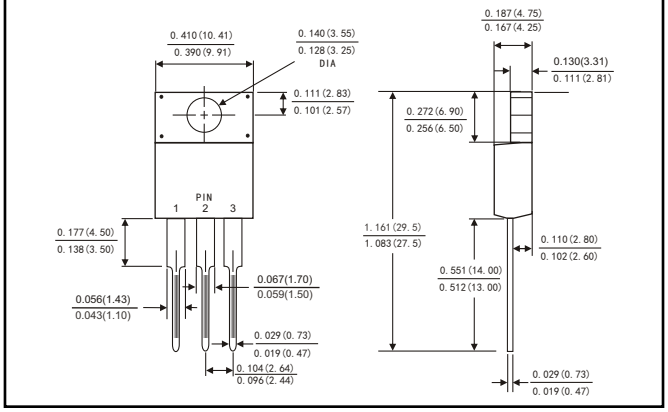
OUTLINE DRAWINGS

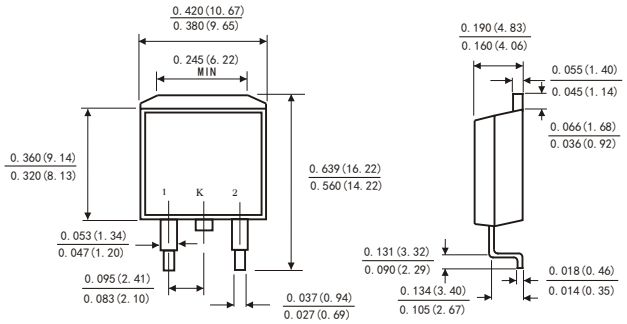
TO-220AB



ITO-220AB

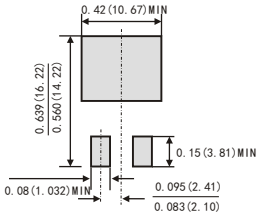


TO-263



Suggested Pad Layout

（TO-263）



ORDER INFORMATION

- Packing information

Product code	Pack	Box Size L×W×H(mm)	Quantity(pcs/box)	Carton SizeL×W×H(mm)	Quantity(box/carton)
TO-220AB	P/T	550×150×40	1000	580×230×175	5
ITO-220AB	P/T	550×150×40	1000	580×230×175	5
TO-263	P/T	550×150×40	1000	580×230×175	5

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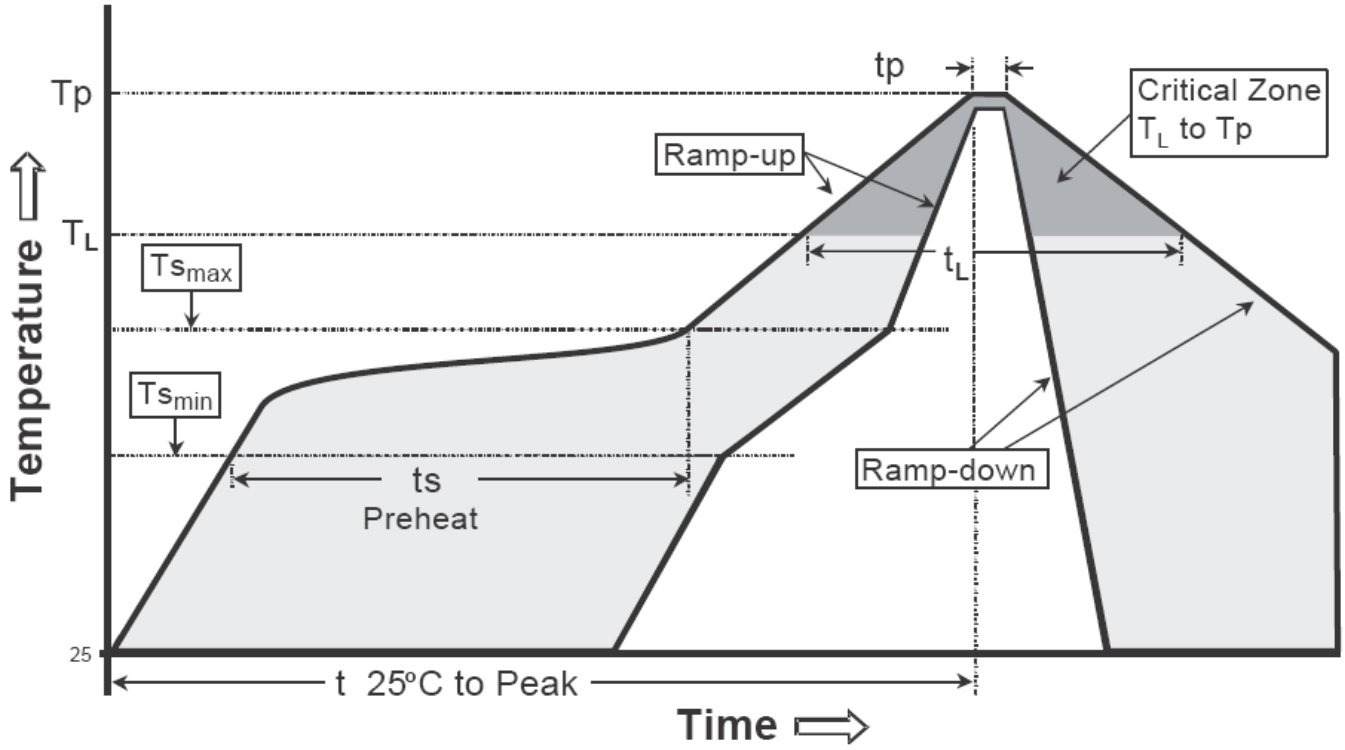
Recommended wave soldering condition

Product	Peak Temperature	Soldering Time
Pb-free devices	260 +0/-5 °C	5 +1/-1 seconds

Recommended temperature profile for IR reflow



Profile feature	Sn-Pb eutectic Assembly	Pb-free Assembly
Average ramp-up rate (Tsmax to Tp)	3°C/second max.	3°C/second max.
Preheat −Temperature Min(Ts min) −Temperature Max(Ts max) −Time(ts min to ts max)	 100°C 150°C 60-120 seconds	 150°C 200°C 60-180 seconds
Time maintained above: −Temperature (TL) − Time (tL)	 183°C 60-150 seconds	 217°C 60-150 seconds
Peak Temperature(TP)	240 +0/-5 °C	260 +0/-5 °C
Time within 5°C of actual peak temperature(tp)	10-30 seconds	20-40 seconds
Ramp down rate	6°C/second max.	6°C/second max.
Time 25 °C to peak temperature	6 minutes max.	8 minutes max.

Note : All temperatures refer to topside of the package, measured on the package body surface.

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